

Molding Type Module IGBT 2-in 1-Package, 1200 V, 75 A



| I | N | T- | Δ. | .P | Δ | ĸ |
|---|---|----|----|----|---|---|
| | | | | | | |

| PRODUCT SUMMARY | | | | | | |
|---|-----------------|--|--|--|--|--|
| V _{CES} | 1200 V | | | | | |
| I_C at $T_C = 80$ °C | 75 A | | | | | |
| $V_{CE(on)}$ (typical) at $I_C = 75$ A, $T_J = 25$ °C | 1.90 V | | | | | |
| Speed | 8 kHz to 30 kHz | | | | | |
| Package | INT-A-PAK | | | | | |
| Circuit | Half bridge | | | | | |

FEATURES

- High short circuit capability, self limiting to 6 x I
- 10 µs short circuit capability
- V_{CE(on)} with positive temperature coefficient
- Low inductance case
- · Fast and soft reverse recovery antiparallel FWD
- Isolated copper baseplate using DCB (Direct Copper Bonding) technology
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>

TYPICAL APPLICATIONS

- AC inverter drivers
- · Electronic welders
- Switching mode power supplies

DESCRIPTION

Vishay's IGBT power module provides ultra low conduction loss as well as short circuit ruggedness. It is designed for applications such as general inverters and UPS.

| PARAMETER | SYMBOL | TEST CONDITIONS | MAX. | UNITS |
|----------------------------------|--------------------------------|--|------|------------------|
| Collector to emitter voltage | V _{CES} | | 1200 | |
| Gate to emitter voltage | V_{GES} | | ± 20 | V |
| Callantan annuant | , | T _C = 25 °C | 150 | |
| Collector current | Ic | T _C = 80 °C | 75 | |
| Pulsed collector current | I _{CM} ⁽¹⁾ | t _p = 1 ms | 150 | Α |
| Diode continuous forward current | I _F | T _C = 80 °C | 75 | |
| Diode maximum forward current | I _{FM} ⁽¹⁾ | t _p = 1 ms | 150 | |
| Maximum power dissipation | P _D | T _J = 150 °C | 543 | W |
| Short circuit withstand time | T _{SC} | T _J = 125 °C | 10 | μs |
| l ² t-value, diode | | $V_R = 0 \text{ V}, \text{ t} = 10 \text{ ms}, \text{ T}_J = 125 ^{\circ}\text{C}$ | 1050 | A ² s |
| RMS isolation voltage | V _{ISOL} | f = 50 Hz, t = 1 min | 2500 | V |
| Maximum junction temperature | TJ | | +150 | °C |

Note

⁽¹⁾ Repetitive rating: pulse width limited by maximum junction temperature.

| IGBT ELECTRICAL SPECIFICATIONS (T _C = 25 °C unless otherwise noted) | | | | | | | | |
|--|----------------------|--|------|------|------|-------|--|--|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS | | |
| Collector to emitter breakdown voltage | V _{(BR)CES} | $V_{GE} = 0 \text{ V}, I_{C} = 1.0 \text{ mA}, T_{J} = 25 \text{ °C}$ | 1200 | - | - | | | |
| Collector to emitter voltage | V | $V_{GE} = 15 \text{ V}, I_{C} = 75 \text{ A}, T_{J} = 25 ^{\circ}\text{C}$ | - | 1.9 | 2.35 | V | | |
| Collector to enfitter voltage | V _{CE(on)} | V _{GE} = 15 V, I _C = 75 A, T _J = 125 °C | - | 2.1 | - |] | | |
| Gate to emitter threshold voltage | V _{GE(th)} | $V_{CE} = V_{GE}$, $I_C = 3.0$ mA, $T_J = 25$ °C | 5.0 | 6.2 | 7.0 | | | |
| Collector cut-off current | I _{CES} | $V_{CE} = V_{CES}$, $V_{GE} = 0$ V, $T_{J} = 25$ °C | - | - | 5.0 | mA | | |
| Gate to emitter leakage current | I _{GES} | $V_{GE} = V_{GES}$, $V_{CE} = 0$ V, $T_{J} = 25$ °C | - | - | 400 | nA | | |



| SWITCHING CHARACTERISTICS | | | | | | | |
|--|----------------------|--|------|------|------|-------|--|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS | |
| Turn-on delay time | t _{d(on)} | | - | 305 | - | - ns | |
| Rise time | t _r | | - | 67 | - | | |
| Turn-off delay time | t _{d(off)} | $V_{CC} = 600 \text{ V}, I_{C} = 75 \text{ A}, R_{g} = 10 \Omega,$ | - | 328 | - | | |
| Fall time | t _f | $V_{GE} = \pm 15 \text{ V}, T_{J} = 25 \text{ °C}$ | - | 187 | - | | |
| Turn-on switching loss | E _{on} | | - | 6.74 | - | - mJ | |
| Turn-off switching loss | E _{off} | | - | 4.25 | - | | |
| Turn-on delay time | t _{d(on)} | | - | 311 | - | ns | |
| Rise time | t _r | | - | 67 | - | | |
| Turn-off delay time | t _{d(off)} | $V_{CC} = 600 \text{ V}, I_{C} = 75 \text{ A}, R_{g} = 10 \Omega,$ | - | 347 | - | | |
| Fall time | t _f | $V_{GE} = \pm 15 \text{ V}, T_{J} = 125 \text{ °C}$ | - | 337 | - | | |
| Turn-on switching loss | E _{on} | | - | 9.75 | - | I | |
| Turn-off switching loss | E _{off} | | - | 7.05 | - | - mJ | |
| Input capacitance | C _{ies} | | - | 5.52 | - | | |
| Output capacitance | C _{oes} | $V_{GE} = 0 \text{ V}, V_{CE} = 25 \text{ V}, f = 1.0 \text{ MHz}, $ $T_{.1} = 25 \text{ °C}$ | - | 0.40 | - | nF | |
| Reverse transfer capacitance | C _{res} | - 1j - 23 O | - | 0.26 | - | | |
| SC data | I _{SC} | $t_{S} \le 10 \ \mu s, \ V_{GE} = 15 \ V, \ T_{J} = 125 \ ^{\circ}C, \ V_{CC} = 900 \ V, \ V_{CEM} \le 1200 \ V$ | - | 350 | - | Α | |
| Internal gate rsistance | R _{GINT} | | - | 3 | - | Ω | |
| Stray inductance | L _{CE} | | - | - | 30 | nΗ | |
| Module lead resistance, terminal to chip | R _{CC'+EE'} | | - | 0.75 | - | mΩ | |

| DIODE ELECTRICAL SPECIFICATIONS (T _C = 25 °C unless otherwise noted) | | | | | | | | |
|--|------------------|--|-------------------------|---|------|------|-----------|--|
| PARAMETER | SYMBOL | TEST CONDIT | TEST CONDITIONS | | TYP. | MAX. | UNITS | |
| Forward voltage | V- | I _F = 75 A | T _J = 25 °C | - | 1.78 | 2.18 | V | |
| Torward voitage | V_{F} | | T _J = 125 °C | - | 1.85 | - | | |
| Poverse receivery charge | Q _{rr} | I _F = 75 A, V _R = 600 V, dI _F /dt = 1300 A/μs V _{GF} = -15 V | T _J = 25 °C | - | 4.0 | - | μC - A | |
| Reverse recovery charge | | | T _J = 125 °C | - | 9.3 | - | | |
| Dools was some was a survent | | | T _J = 25 °C | - | 55 | - | | |
| Peak reverse recovery current | I _{rr} | | T _J = 125 °C | - | 73 | - | | |
| Poverse receivent energy | _ | Q_ | T _J = 25 °C | - | 2.98 | - | m l | |
| Reverse recovery energy | E _{rec} | | T _J = 125 °C | - | 4.46 | - | mJ | |

| THERMAL AND MECHANICAL SPECIFICATIONS | | | | | | | | |
|--|-------|-------------------|--------------------------|------|------------|------|-------|--|
| PARAMETER | | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS | |
| Maximum junction temperature | | T_J | | - | - | 150 | °C | |
| Storage temperature range | | T _{Stg} | | -40 | - | 125 | °C | |
| Junction to case | IGBT | | | - | - | 0.23 | | |
| per ½ module | Diode | R _{thJC} | | - | =. | 0.33 | K/W | |
| Case to sink (Conductive grease applied) | | R _{thCS} | | - | 0.05 | - | | |
| Mounting torque | | | Power terminal screw: M5 | | 2.5 to 5.0 | | Nima | |
| | | | Mounting screw: M6 | | 3.0 to 5.0 |) | Nm | |
| Weight | | | Weight of module | - | 150 | - | g | |



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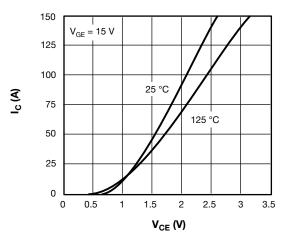


Fig. 1 - IGBT Typical Output Characteristics

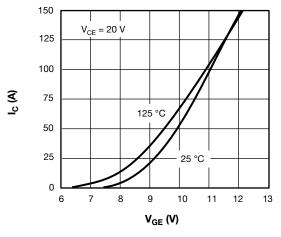


Fig. 2 - IGBT Typical Transfer Characteristics

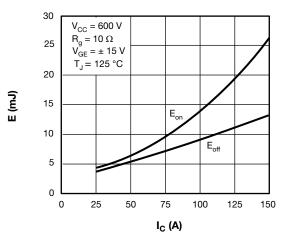


Fig. 3 - IGBT Switching Loss vs. I_C

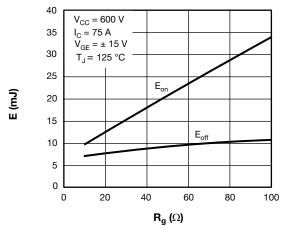
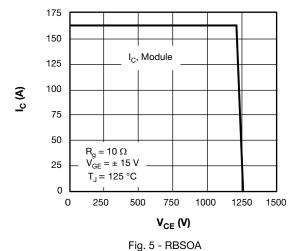


Fig. 4 - IGBT Switching Loss vs. R_q



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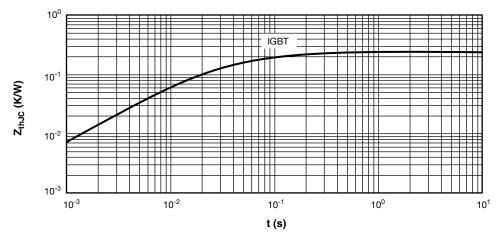


Fig. 6 - IGBT Transient Thermal Impedance

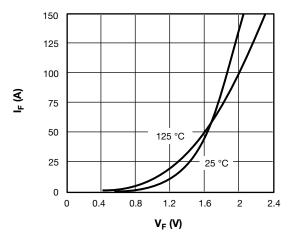


Fig. 7 - Typical Diode Forward Characteristics

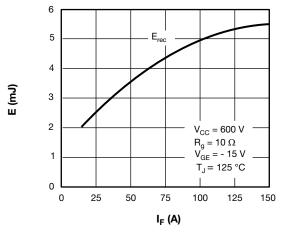


Fig. 8 - Diode Switching Loss vs. I_F

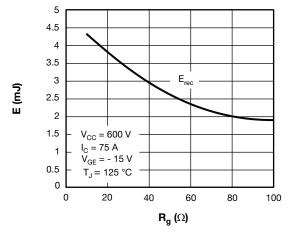


Fig. 9 - Diode Switching Loss vs. Rq

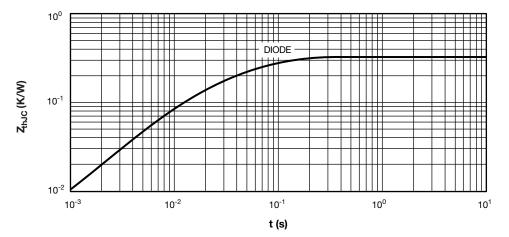
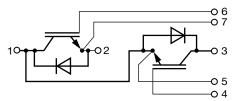


Fig. 10 - Diode Transient Thermal Impedance

CIRCUIT CONFIGURATION

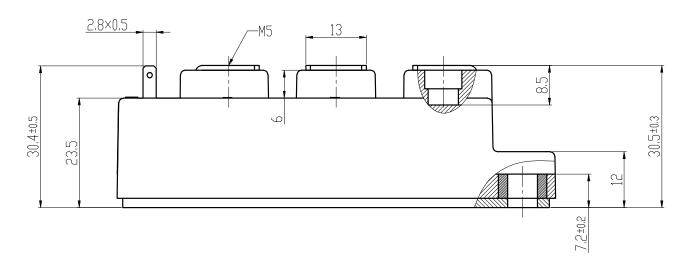


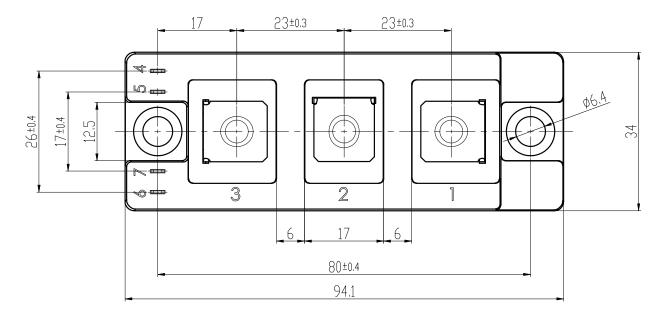
| LINKS TO RELATED DOCUMENTS | | | | | |
|----------------------------|--------------------------|--|--|--|--|
| Dimensions | www.vishay.com/doc?95524 | | | | |



INT-A-PAK

DIMENSIONS in millimeters (inches)







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